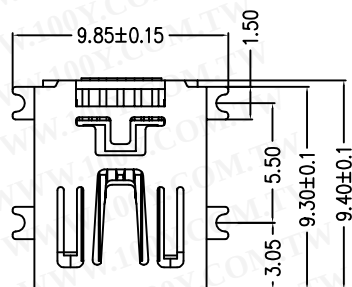
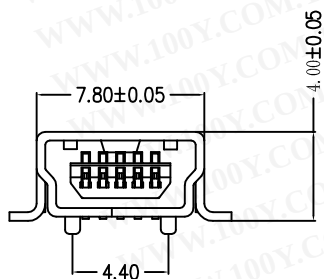
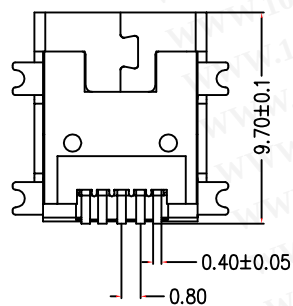
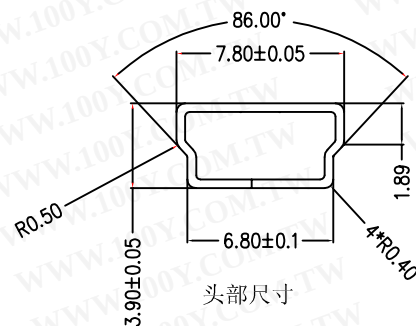


PCB LAYOUT

特性:Specifications:

电器:Electrical:

接触阻抗:Contact Resistance

30 milliohms MAX

耐电压:Dielectric Withstanding Voltage:

500 V AC AT Sea Level

绝缘阻抗:Insulation Resistance:

100 MEGA ohms MIN

材料:Material:

塑胶:Housing:High Temperature Thermoplastics,

LCP 耐高温塑胶

端子>Contact: Copper Alloy 铜合金

铜壳:Shell: Copper Alloy 铜合金

电镀:Finish:

端子>Contact: Plated Gold in Mating Area;

Tin On Solder Tails

接触点镀金. 脚镀锡

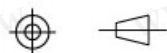
铜壳:Shell:

Nickel/ Plating 镀镍

勝特力材料 886-3-5753170
勝特力电子(上海) 86-21-34970699
勝特力电子(深圳) 86-755-83298787
[Http://www.100y.com.tw](http://www.100y.com.tw)

TOLERANCE UNLESS
OTHERWISE SPECIFIED

XXX	±0.10
XX	±0.20
X	±0.30
X°	±2°



Third Angle Project

DRAM NO	KCD	DATE	DRAW NAME
DWN	林云	11.05.20	MINI USB 5P/F SMT 铜壳
CHK			
APVD			P/N:

FINISH

MATERIAL

UNIT

mm

SCALE

1:1

WEIGHT

REV

SHEET

1 OF 1